

3A, 50V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Low forward voltage drop
- Low profile package
- Fast switching for high efficiency
- Ideal for automated placement
- Glass passivated chip junction
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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4	_			4		NS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.093g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _F	3	Α			
V_{RRM}	50 - 1000	V			
I _{FSM}	100	Α			
T_{JMAX}	150 °C				
Package	DO-214AA (SMB)				
Configuration	Single die				





DO-214AA (SMB)



	SYMBOL	HS	HS	HS	HS	HS	HS	HS	HS	
PARAMETER		ЗАВ	3ВВ	3DB	3FB	3GB	3JB	3КВ	3МВ	UNIT
		Н	Н	Н	Н	Н	Н	Н	Н	
Moulting and an the device		HS	HS	HS	HS	HS	HS	HS	HS	
Marking code on the device		3AB	3BB	3DB	3FB	3GB	3JB	3KB	3MB	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	210	280	420	560	700	V
Forward current	I _F	3					Α			
Surge peak forward current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	100						А		
Junction temperature	T _J	- 55 to +150						°C		
Storage temperature	T _{STG}	- 55 to +150					°C			



THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	60	°C/W			

PARAMETER	CONDITIONS	SYMBOL	TYP	МАХ	UNIT	
40	HS3ABH HS3BBH HS3DBH HS3FBH			-	1.0	V V V
Forward voltage ⁽¹⁾	HS3GBH	$I_F = 3A, T_J = 25^{\circ}C$	V _F	-	1.3	V
	HS3JBH HS3KBH HS3MBH			-	1.7	V V V
D (2)	1	T _J = 25°C		-	10	μA
Reverse current @ rated V _R ⁽²⁾		T _J = 100°C	- I _R	-	250	μA
Junction capacitance	HS3ABH HS3BBH HS3FBH HS3GBH HS3JBH HS3KBH HS3MBH	1MHz, V _R = 4.0V	CJ	80 50	-	pF pF pF pF pF pF
Reverse recovery time	HS3ABH HS3BBH HS3DBH HS3FBH HS3GBH	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t _{rr}	-	50	ns ns ns ns
	HS3JBH HS3KBH HS3MBH			-	75	ns ns ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING				
HS3xBH	DO-214AA (SMB)	3,000 / Tape & Reel				

Notes:

1. "x" defines voltage from 50V(HS3ABH) to 1000V(HS3MBH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

3.5 AVERAGE FORWARD CURRENT (A) 3 2.5 2 1.5 1 0.5 0 0 25 50 75 100 125 150 175 LEAD TEMPERATURE (°C)

Fig.2 Typical Junction Capacitance

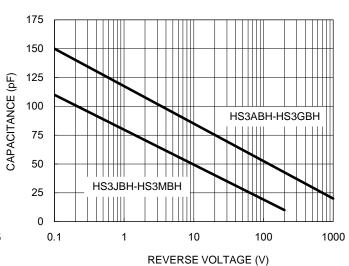


Fig.3 Typical Reverse Characteristics

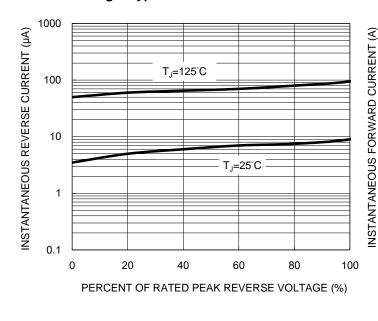
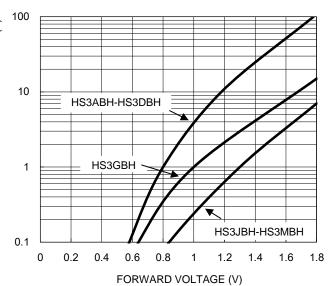


Fig.4 Typical Forward Characteristics



Version: A2102

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CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

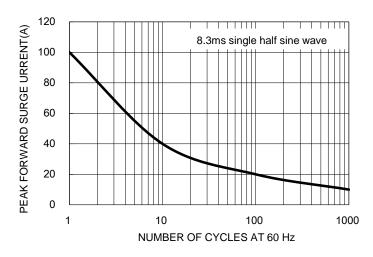
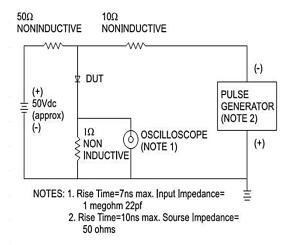
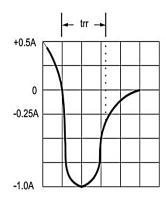
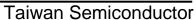


Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram





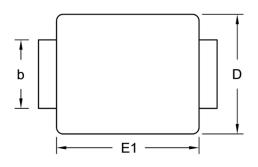
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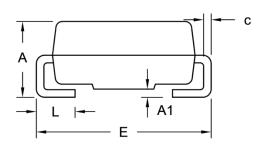




PACKAGE OUTLINE DIMENSIONS

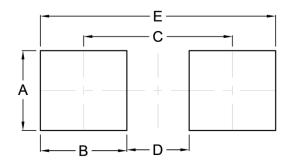
DO-214AA (SMB)





DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.	
Α	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
С	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

MARKING DIAGRAM



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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